

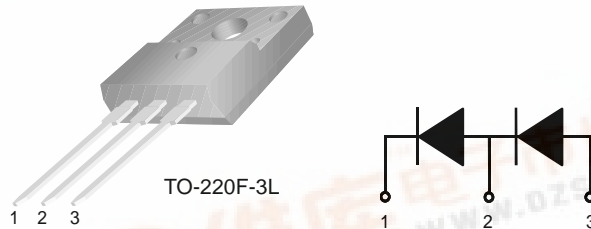
**FAIRCHILD**  
SEMICONDUCTOR®

**Stealth™ Rectifier**

**FFPF60SA60DS**

**Features**

- Soft Recovery ( $t_b / t_a > 1.2$ )
- Fast Recovery ( $t_{rr} < 25\text{ns}$ )
- Reverse Voltage, 600V
- Forward Voltage (@  $T_C = 125^\circ\text{C}$ ),  $< 2.0\text{ V}$
- Enhanced Avalanche Energy



**Applications**

- Switch Mode Power Supplies
- Hard Switched PFC Boost Diode
- UPS Free wheeling Diode
- Motor Drive FWD
- SMPS FWD
- Snubber Diode

**Absolute Maximum Ratings (per leg)  $T_C=25^\circ\text{C}$  unless otherwise noted**

Symbol	Parameter	Value	Units
$V_{RRM}$	Peak Repetitive Reverse Voltage	600	V
$V_{RWM}$	Working Peak Reverse Voltage	600	V
$V_R$	DC Blocking Voltage	600	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 95^\circ\text{C}$	8	A
$I_{FSM}$	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	80	A
$P_D$	Power Dissipation	26	W
$W_{AVL}$	Avalanche Energy (1A, 40mH)	20	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature	- 65 to +150	$^\circ\text{C}$

**Thermal Characteristics**

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.125	$^\circ\text{C/W}$
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	62.5	$^\circ\text{C/W}$

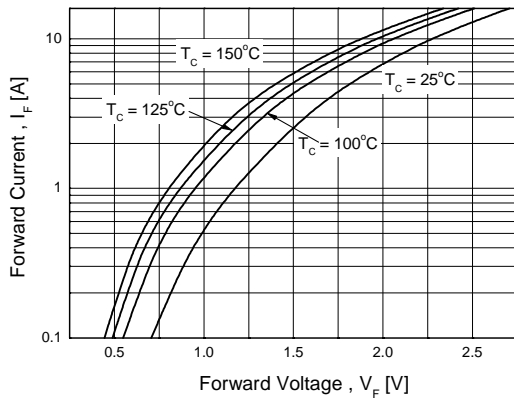


**Electrical Characteristics (per leg)  $T_C=25^\circ\text{C}$  unless otherwise noted**

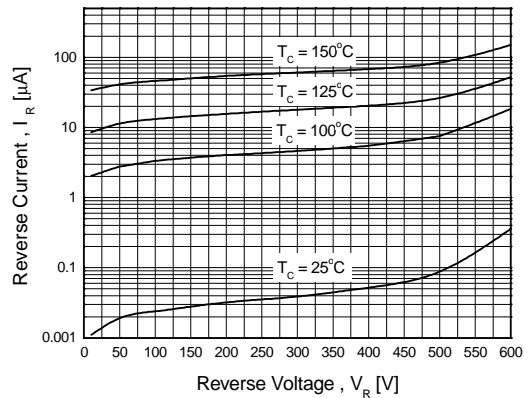
Symbol	Parameter	Min.	Typ.	Max.	Units	
$V_{FM}^*$	Maximum Instantaneous Forward Voltage $I_F = 8\text{A}$ $I_F = 8\text{A}$	$T_C = 25^\circ\text{C}$	-	2.0	2.4	V
		$T_C = 125^\circ\text{C}$	-	1.6	2.0	
$I_{RM}^*$	Maximum Instantaneous Reverse Current @ rated $V_R$	$T_C = 25^\circ\text{C}$	-	-	100	$\mu\text{A}$
		$T_C = 125^\circ\text{C}$	-	-	1000	
$t_{rr}$	Maximum Reverse Recovery Time ( $I_F = 1\text{A}$ , $di/dt = 100\text{A}/\mu\text{s}$ , $V_R = 30\text{V}$ )	-	-	25	ns	
$t_{rr}$	Maximum Reverse Recovery Time ( $I_F = 8\text{A}$ , $di/dt = 100\text{A}/\mu\text{s}$ , $V_R = 30\text{V}$ )	-	-	30	ns	
$t_{rr}$	Reverse Recovery Time	-	39	-	ns	
$I_{rr}$	Reverse Recovery Current	-	2	-	A	
$Q_{rr}$	Reverse Recovery Charge ( $I_F = 8\text{A}$ , $di/dt = 200\text{A}/\mu\text{s}$ , $V_R = 390\text{V}$ )	-	39	-	nC	

\* Pulse Test: Pulse Width=300 $\mu\text{s}$ , Duty Cycle=2%

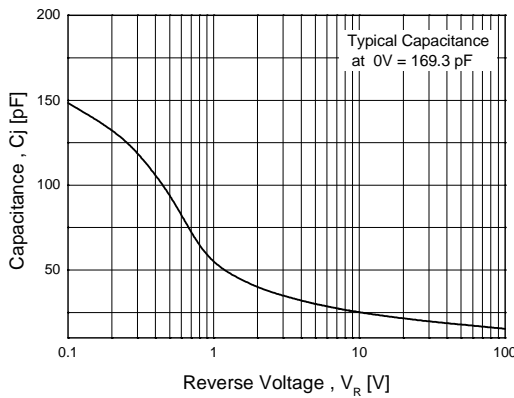
**Typical Characteristics**



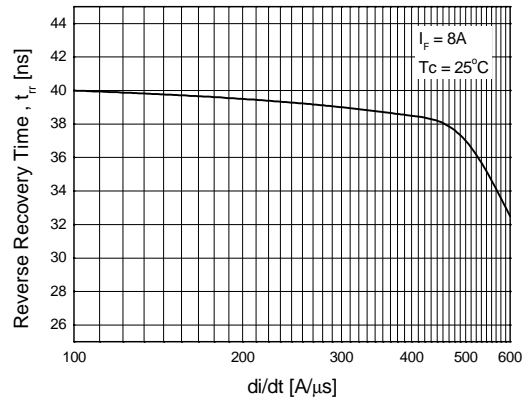
**Figure 1. Typical Forward Voltage Drop vs. Forward Current**



**Figure 2. Typical Reverse Current vs. Reverse Voltage**



**Figure 3. Typical Junction Capacitance**



**Figure 4. Typical Reverse Recovery Time vs. di/dt**

Typical Characteristics (Continued)

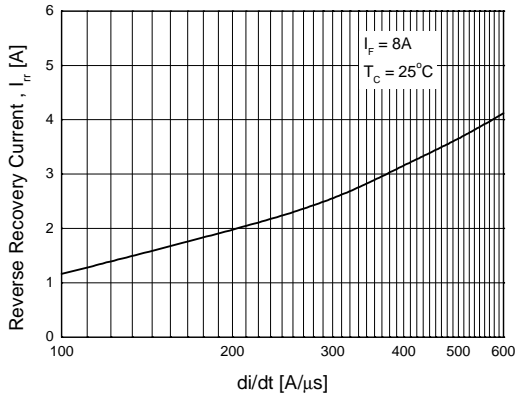


Figure 5. Typical Reverse Recovery Current vs. di/dt

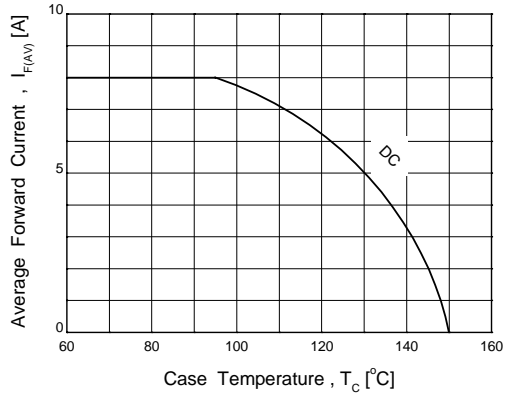


Figure 6. Forward Current Derating Curve

Test Circuits and Waveforms

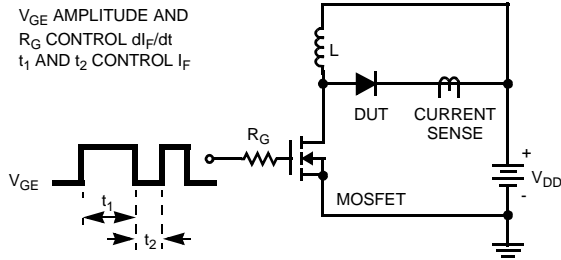


Figure 7.  $t_{rr}$  Test Circuit

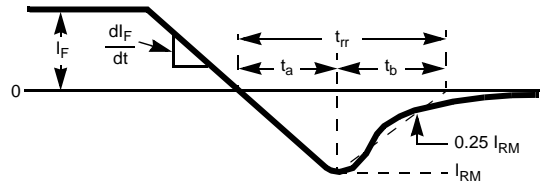


Figure 8.  $t_{rr}$  Waveforms and Definitions

$I = 1A$   
 $L = 40mH$   
 $R < 0.1\Omega$   
 $V_{DD} = 50V$   
 $E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$   
 $Q_1 = IGBT (BV_{CES} > DUT V_{R(AVL)})$

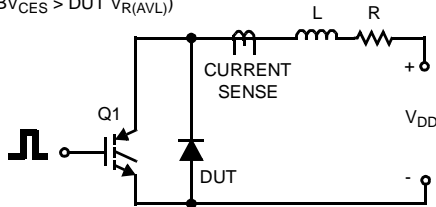


Figure 9. Avalanche Energy Test Circuit

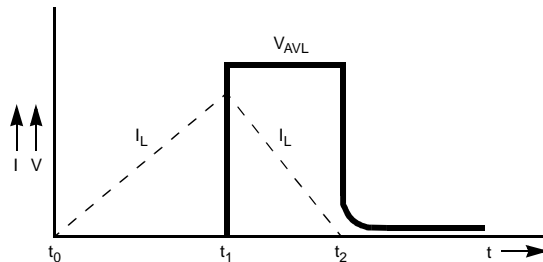
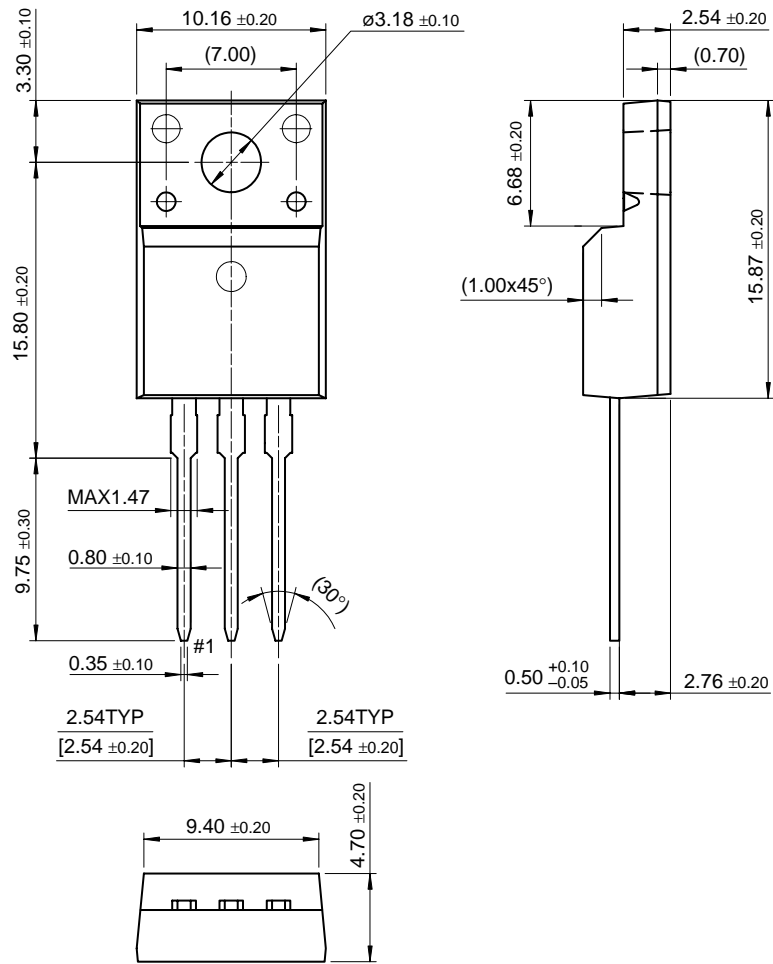


Figure 10. Avalanche Current and Voltage Waveforms

# Package Dimensions

## TO-220F



FFPF60SA60DS

Dimensions in Millimeters

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